



SEMICONDUCTOR

GPRC

# GF10A THRU GF10M

Surface Mount Glass Passivated Rectifier  
Reverse Voltage - 50 to 1000 Volts  
Forward Current - 1.0Ampere

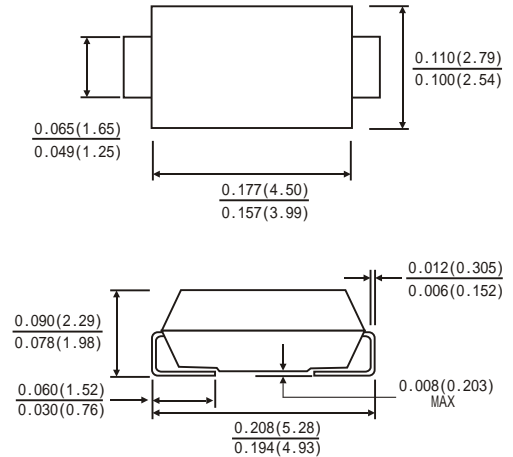
SILICON RECTIFIER

## FEATURES

- GPRC( Glass Passivated Rectifier Chip) inside
  - Glass passivated cavity-free junction Plastic package has Underwriters Laboratory
  - Flammability Classification 94V-0
  - Construction utilizes void-free molded plastic technique
- For surface mounted applications
- Built-in strain relief, ideal for automated placement
- High temperature soldering:  
250° C/10 seconds at terminals



## SMA(DO-214AC)



Dimensions in inches and (millimeters)

## MECHANICAL DATA

- Case: JEDEC DO-214AC molded plastic over glass passivated chip
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Polarity: Color band denotes cathode end
- Weight: 0.002 oz., 0.064 g

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25° C ambient temperature unless otherwise specified ,Single phase ,half wave 60Hz.,resistive or inductive load. For capacitive load, derate by 20%.)

	Symbols	GF 10A	GF 10B	GF 10D	GF 10G	GF 10J	GF 10K	GF 10M	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	Volts
Maximum average Forward Rectified Current 0.375"(9.5mm) lead length at $T_A=75^\circ\text{C}$	$I_{(AV)}$	1.0							Amp
Peak Forward Surge Current (8.3ms half sine-wave superimposed on rated load (JEDEC method) $T_A=75^\circ\text{C}$	$I_{FSM}$	30.0							Amps
Maximum Instantaneous Forward Voltage at 1.0 A	$V_F$	1.0							Volts
Maximum Reverse current at rated DC Blocking Voltage	$T_A = 25^\circ\text{C}$	5.0							$\mu\text{A}$
	$T_A = 100^\circ\text{C}$	50.0							
Typical Thermal resistance (Note 2)	$R_{\theta JA}$	75							$^\circ\text{C/W}$
	$R_{\theta JL}$	27							
Typical Junction Capacitance(Note 1)	$C_J$	12							PF
Maximum DC Blocking Voltage temperature	$T_A$	+150							$^\circ\text{C}$
Operating and Storage temperature Range	$T_J$	-50 to +175							$^\circ\text{C}$
	$T_{STG}$								

Note: 1.Measured at 1MHz and applied reverse voltage of 4.0V DC.

2.Thermal resistance from junction to ambient and from junction to lead at 0.375"(9.5mm)lead length, P.C.B. mounted

# RATINGS AND CHARACTERISTIC CURVES GF10A THRU GF10M

FIG.1-FORWARD CURRENT DERATING CURVE

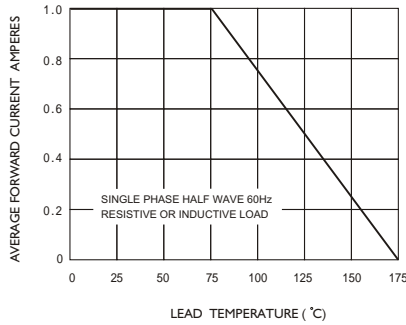


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

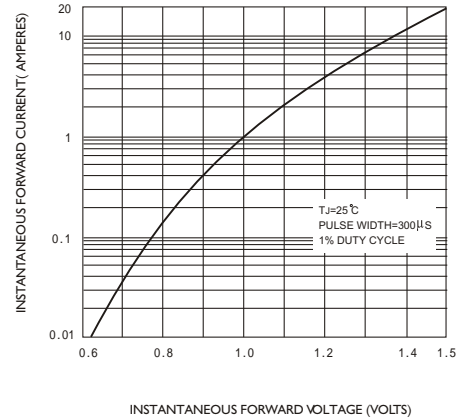


FIG.3-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

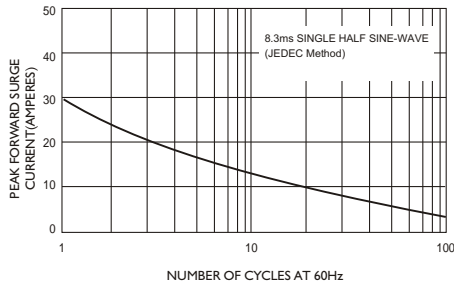


FIG.4-TYPICAL REVERSE CHARACTERISTICS

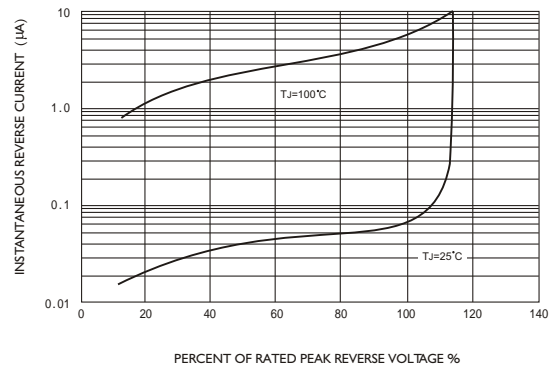


FIG.5-TYPICAL JUNCTION CAPACITANCE

